



Truesemi

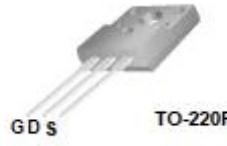
## TSP8N60M/TSF8N60M 600V N-Channel MOSFET

### General Description

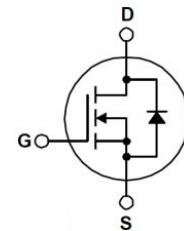
This Power MOSFET is produced using Truesemi's advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.



TO-220



TO-220F



### Features

- 7.5A,600V,Max. $R_{DS(on)}$ =1.20 Ω @  $V_{GS}$ =10V
- Low gate charge(typical 29nC)
- High ruggedness
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

### Absolute Maximum Ratings

 $T_C=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	TSP8N60M	TSF8N60M	Units
$V_{DSS}$	Drain-Source Voltage	600		V
$V_{GS}$	Gate-Source Voltage		± 30	V
$I_D$	Drain Current	$T_C = 25^\circ\text{C}$	7.5	7.5*
		$T_C = 100^\circ\text{C}$	4.5	4.5*
$I_{DM}$	Pulsed Drain Current (Note 1)	30	30*	A
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	267		mJ
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	15.2		mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ (Note 3)	4.5		V/ns
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ ) -Derate above 25°C	152	50	W
		1.21	0.40	W/°C
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150		°C
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300		°C

\* Drain current limited by maximum junction temperature.

### Thermal Resistance Characteristics

Symbol	Parameter	TSP8N60M	TSF8N60M	Units
$R_{\theta JC}$	Thermal Resistance,Junction-to-Case	0.82	2.5	°C/W
$R_{\theta CS}$	Thermal Resistance,Case-to-Sink Typ.	0.5	--	°C/W
$R_{\theta JA}$	Thermal Resistance,Junction-to-Ambient	62.5	62.5	°C/W

## Electrical Characteristics $T_c=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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### On Characteristics

$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$	2.0	--	4.0	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$ , $I_D = 3.75 \text{ A}$	--	0.98	1.20	$\Omega$
$Y_{FS}$	Forward Transconductance	$V_{DS} = 20 \text{ V}$ , $I_D = 3.75 \text{ A}$	--	8.5	--	S

### Off Characteristics

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	600	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.7	--	$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}$ , $V_{GS} = 0 \text{ V}$	--	--	1	$\mu\text{A}$
		$V_{DS} = 480 \text{ V}$ , $T_J = 125^\circ\text{C}$	--	--	10	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current,Forward	$V_{GS} = 30 \text{ V}$ , $V_{DS} = 0 \text{ V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current,Reverse	$V_{GS} = -30 \text{ V}$ , $V_{DS} = 0 \text{ V}$	--	--	-100	nA

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 25 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1.0 \text{ MHz}$	--	1000	--	pF
$C_{oss}$	Output Capacitance		--	110	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	12.6	--	pF

### Switching Characteristics

$t_{d(on)}$	Turn-On Time	$V_{DS} = 300 \text{ V}$ , $I_D = 7.5 \text{ A}$ , $R_G = 25 \Omega$ (Note 4,5)	--	20	--	ns
$t_r$	Turn-On Rise Time		--	50	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	80	--	ns
$t_f$	Turn-Off Fall Time		--	70	--	ns
$Q_g$	Total Gate Charge	$V_{DS} = 480 \text{ V}$ , $I_D = 7.5 \text{ A}$ , $V_{GS} = 10 \text{ V}$ (Note 4,5)	--	29	--	nC
$Q_{gs}$	Gate-Source Charge		--	4.7	--	nC
$Q_{gd}$	Gate-Drain Charge		--	12.5	--	nC

### Source-Drain Diode Maximum Ratings and Characteristics

$I_S$	Continuous Source-Drain Diode Forward Current	--	--	7.5	A	
$I_{SM}$	Pulsed Source-Drain Diode Forward Current	--	--	30.0		
$V_{SD}$	Source-Drain Diode Forward Voltage	$I_S = 7.5 \text{ A}$ , $V_{GS} = 0 \text{ V}$	--	--	1.5	V
$t_{rr}$	Reverse Recovery Time	$I_S = 7.5 \text{ A}$ , $V_{GS} = 0 \text{ V}$ $dI/dt = 100 \text{ A}/\mu\text{s}$ (Note 4)	--	350	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	3.3	--	uC

#### NOTES:

- Repetitive Rating: Pulse width limited by maximum junction temperature
- $L=10\text{mH}$ ,  $I_{AS}=7.5\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $TJ=25^\circ\text{C}$
- $I_{SD}\leq 7.5\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $TJ = 25^\circ\text{C}$
- Pulse Test: Pulse width  $\leq 300\text{us}$ , Duty Cycle  $\leq 2\%$
- Essentially Independent of Operating Temperature Typical Characteristics

## Typical Characteristics

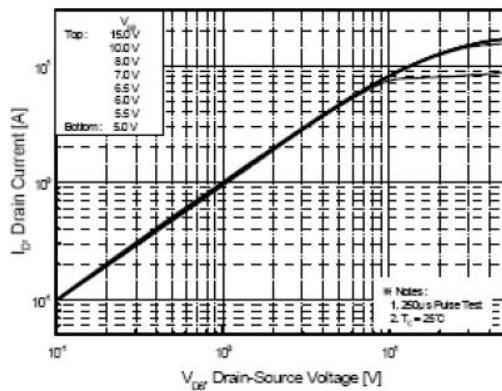


Figure 1. On-Region Characteristics

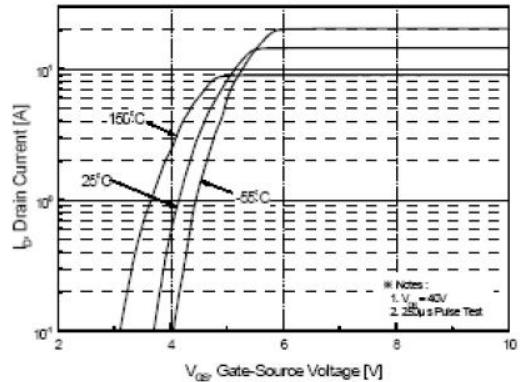


Figure 2. Transfer Characteristics

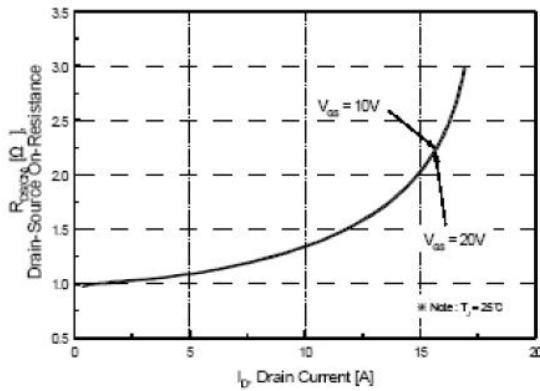


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

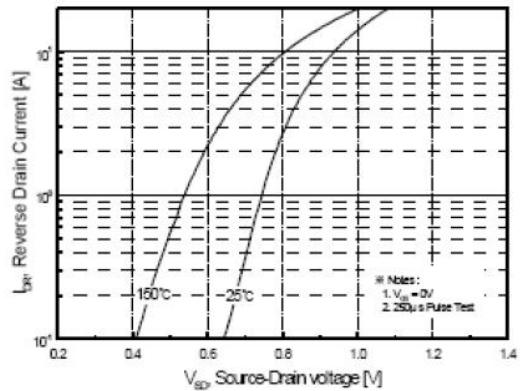


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

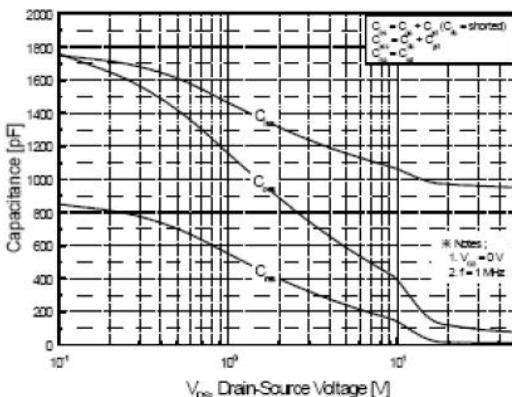


Figure 5. Capacitance Characteristics

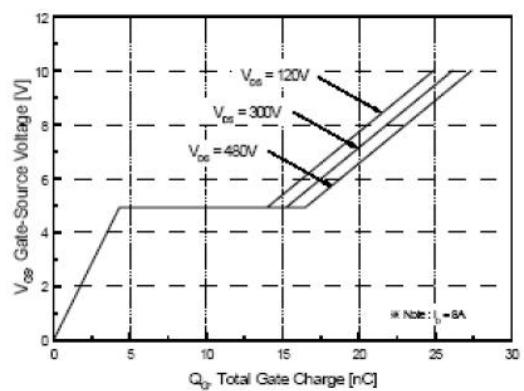
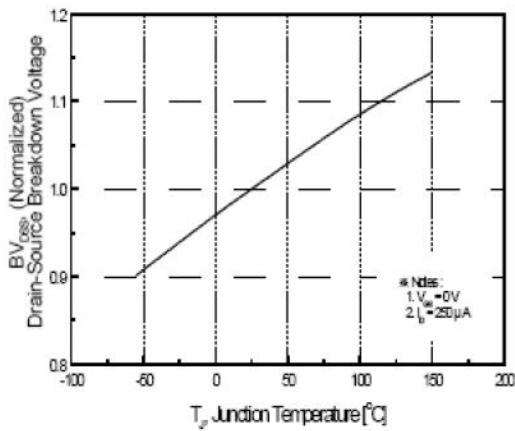
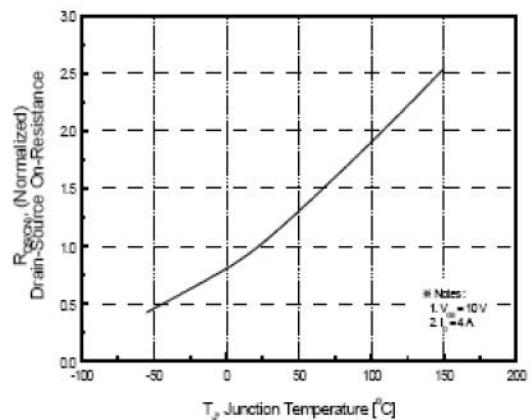


Figure 6. Gate Charge Characteristics

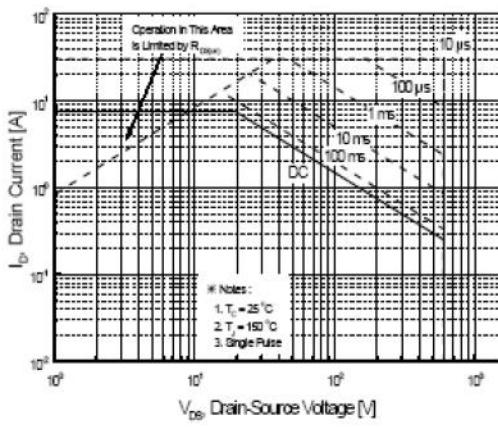
## Typical Characteristics



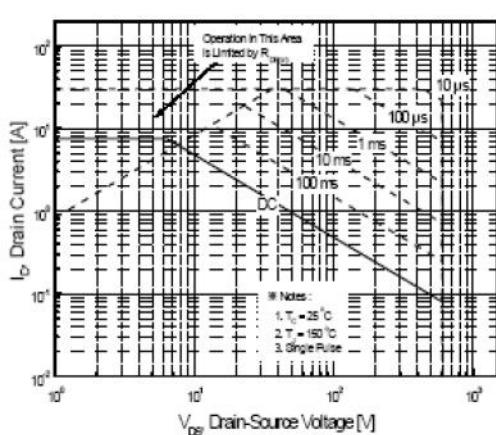
**Figure 7. Breakdown Voltage Variation vs Temperature**



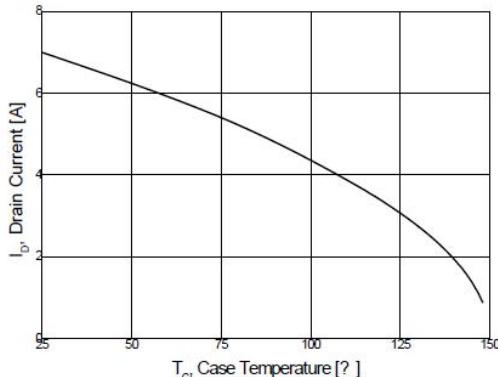
**Figure 8. On-Resistance Variation vs Temperature**



**Figure 9-1. Maximum Safe Operating Area for TSP8N60M**

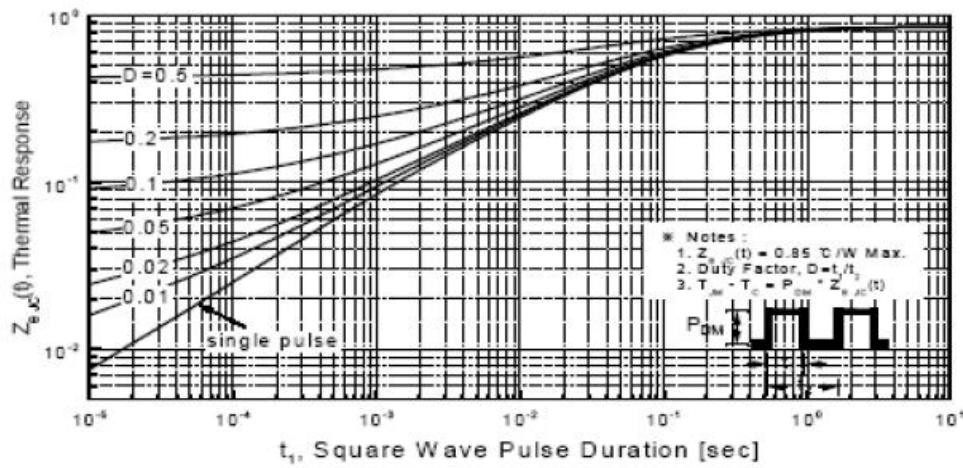


**Figure 9-2. Maximum Safe Operating Area for TSF8N60M**

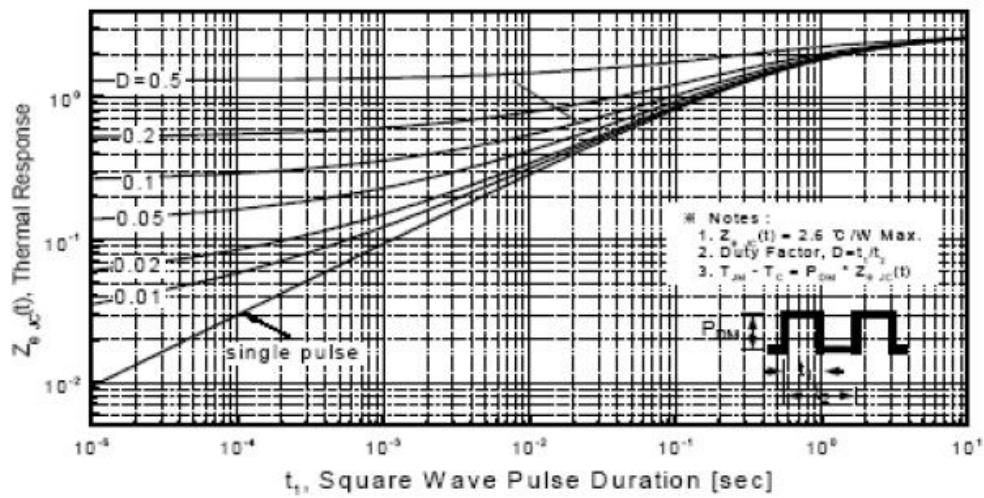


**Figure 10. Maximum Drain Current vs Case Temperature**

## Typical Characteristics



**Figure 11-1. Transient Thermal Response Curve  
for TSP8N60M**



**Figure 11-2. Transient Thermal Response Curve  
for TSF8N60M**

Fig 12. Gate Charge Test Circuit &amp; Waveform

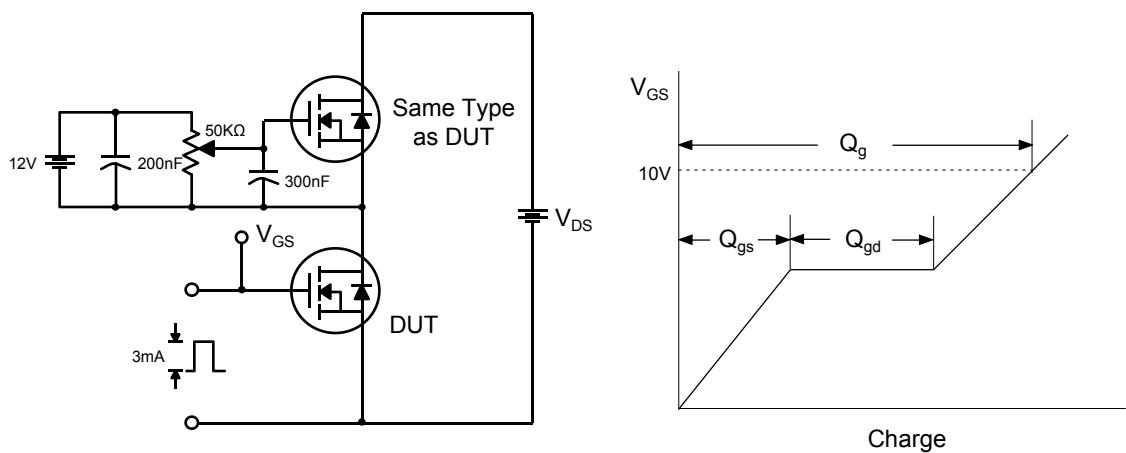


Fig 13. Resistive Switching Test Circuit &amp; Waveforms

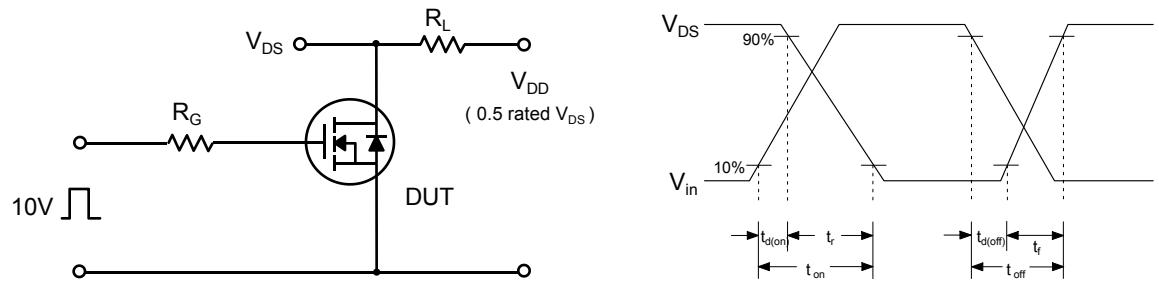


Fig 14. Unclamped Inductive Switching Test Circuit &amp; Waveforms

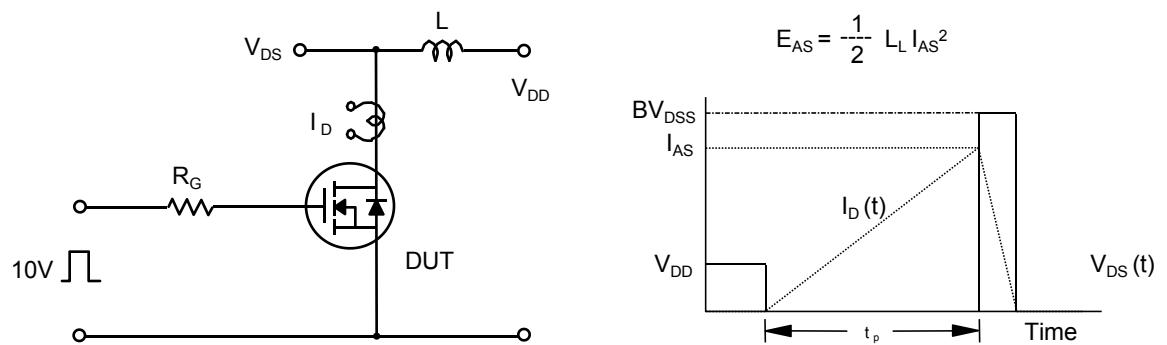
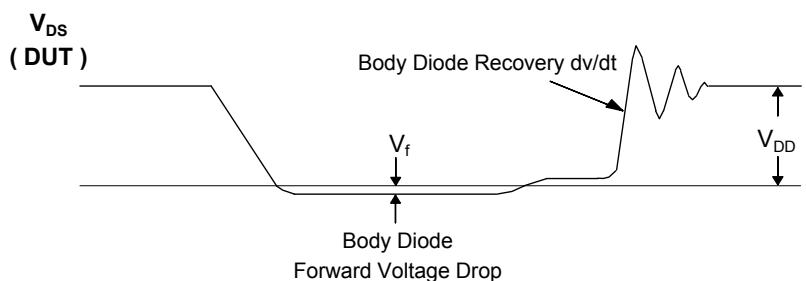
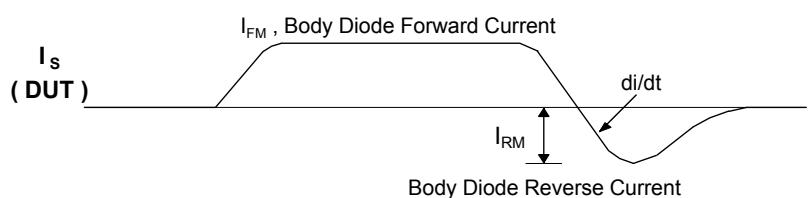
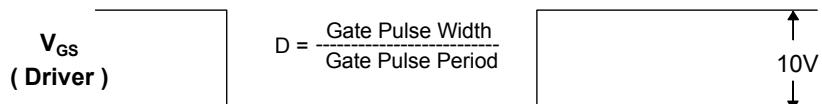
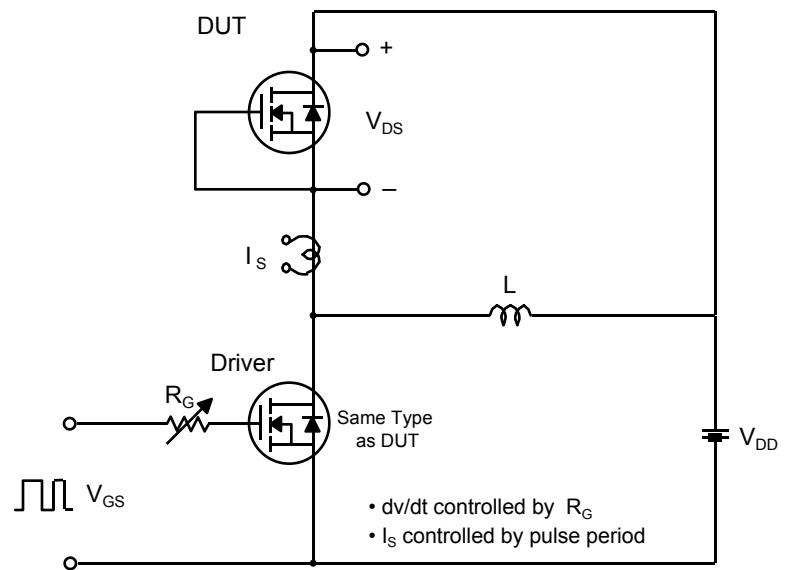
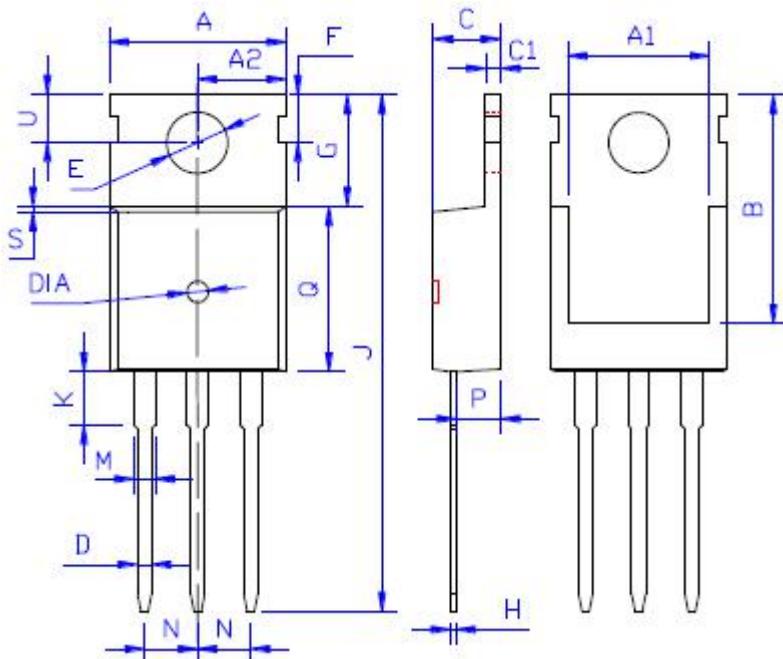


Fig 15. Peak Diode Recovery dv/dt Test Circuit &amp; Waveforms



## Package Dimension

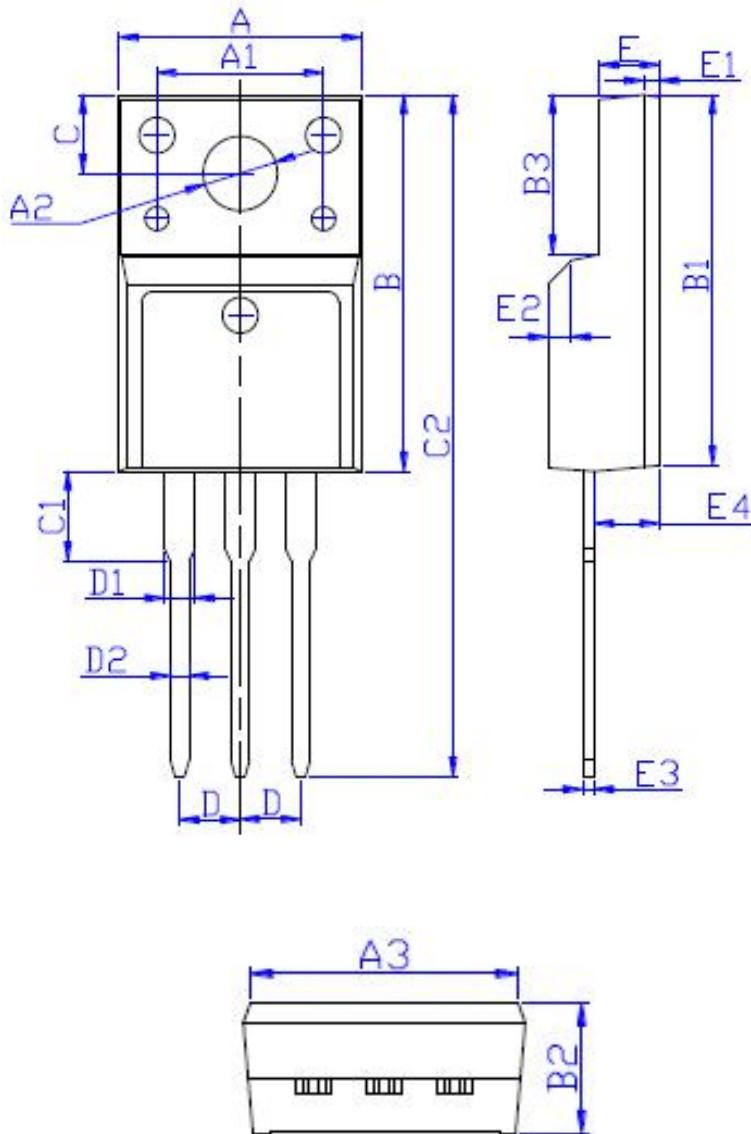
## TO-220



DIM	MILLIMETERS
A	10.00±0.30
A1	8.00±0.30
A2	5.00±0.30
B	13.20±0.40
C	4.50±0.20
C1	1.30±0.20
D	0.80±0.20
E	3.60±0.20
F	3.00±0.30
G	6.60±0.40
H	0.50±0.20
J	28.88±0.50
K	3.00±0.30
M	1.30±0.30
N	Typical 2.54
P	2.40±0.40
Q	9.20±0.40
S	0.25±0.15
T	0.25±0.15
U	2.80±0.30
DIA	宽 1.50±0.10 深 0.50 MAX

## Package Dimension

## TO-220F



DIM	MILLIMETERS
<b>A</b>	$10.16 \pm 0.30$
<b>A1</b>	$7.00 \pm 0.20$
<b>A2</b>	$3.12 \pm 0.20$
<b>A3</b>	$9.70 \pm 0.30$
<b>B</b>	$15.90 \pm 0.50$
<b>B1</b>	$15.60 \pm 0.50$
<b>B2</b>	$4.70 \pm 0.30$
<b>B3</b>	$6.70 \pm 0.30$
<b>C</b>	$3.30 \pm 0.25$
<b>C1</b>	$3.25 \pm 0.30$
<b>C2</b>	$28.70 \pm 0.50$
<b>D</b>	Typical 2.54
<b>D1</b>	1.47 (MAX)
<b>D2</b>	$0.80 \pm 0.20$
<b>E</b>	$2.55 \pm 0.25$
<b>E1</b>	$0.70 \pm 0.25$
<b>E2</b>	$1.0 \times 45^\circ$
<b>E3</b>	$0.50 \pm 0.20$
<b>E4</b>	$2.75 \pm 0.30$

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